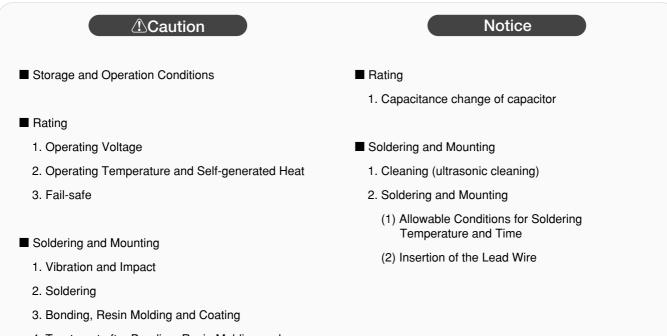
Caution/Notice



4. Treatment after Bonding, Resin Molding and Coating

Storage and Operation Conditions

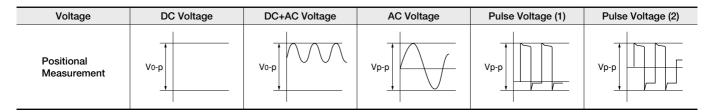
The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. Also avoid exposure to moisture. Before cleaning, bonding or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed 5 to 40 degrees centigrade and 20 to 70%. Use capacitors within 6 months after delivery.

Rating

1. Operating Voltage

When DC-rated capacitors are to be used in AC or ripple current circuits, be sure to maintain the Vp-p value of the applied voltage or the V0-p which contains DC bias within the rated voltage range.

When the voltage is applied to the circuit, starting or stopping may generate irregular voltage for a transit period because of resonance or switching. Be sure to use a capacitor with a rated voltage range that includes these irregular voltages. When DC-rated capacitors are to be used in input circuits from commercial power source (AC filter), be sure to use Safety Recognized Capacitors because various regulations on withstand voltage or impulse withstand established for all equipment should be taken into consideration.



2. Operating Temperature and Self-generated Heat

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself. When the capacitor is used in a high-frequency current, pulse current or similar current, it may have self-generated heat due to dielectric loss. In the case of "High Dielectric Constant Type Capacitors," applied voltage load should be such that self-generated heat is within 20 °C under the condition where the capacitor is subjected at an atmosphere temperature of 25 °C. Please contact us if self-generated heat occurs with "Temperature Compensating Type Capacitors".

3. Fail-Safe

Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product. When measuring, use a thermocouple of small thermal capacity -K of Ø0.1mm under conditions where the capacitor is not affected by radiant heat from other components or wind from surroundings. Excessive heat may lead to deterioration of the capacitor's characteristics and reliability. Never attempt to perform measurement with the cooling fan running. Otherwise, accurate measurement cannot be ensured.



Continued from the preceding page.

Soldering and Mounting

1. Vibration and Impact

Do not expose a capacitor or its leads to excessive shock or vibration during use.

2. Soldering

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

3. Bonding, Resin Molding and Coating

In case of bonding, molding or coating this product, verify that these processes do not affect the quality of the capacitor by testing the performance of the bonded, molded or coated product in the intended equipment.

In case the amount of application, dryness/ hardening conditions of adhesives and molding resins containing organic solvents (ethyl acetate, methyl ethyl ketone, toluene, etc.) are unsuitable, the outer coating resin of a capacitor may be damaged by the organic solvents and may result, worst case, in a short circuit.

The variation in thickness of adhesive or molding resin or coating may cause an outer coating resin cracking and/or ceramic element cracking of a capacitor in a temperature cycling.

4. Treatment after Bonding, Resin Molding and Coating When the outer coating is hot (over 100 degrees centigrade) after soldering, it becomes soft and fragile, so please be careful not to give it mechanical stress.

FAILURE TO FOLLOW THE ABOVE CAUTIONS MAY RESULT, WORST CASE, IN A SHORT CIRCUIT AND CAUSE FUMING OR PARTIAL DISPERSION WHEN THE PRODUCT IS USED.



Notice

Rating

1. Capacitance change of capacitor

In case of F/X7R/X7S/X7T/X8L/Y5V/Z5U char. Capacitors have an aging characteristic, whereby the capacitor continually decreases its capacitance slightly if the capacitor is left on for a long time. Moreover, capacitance might change greatly depending on the surrounding temperature or an applied voltage.

Soldering and Mounting

1. Cleaning (ultrasonic cleaning)

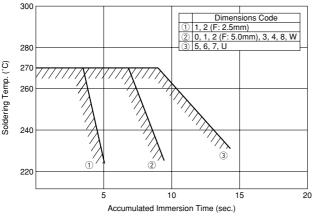
To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity: Output of 20 watts per liter or less. Rinsing time: 5 min. maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

2. Soldering and Mounting



Perform soldering within tolerance range (shaded portion).

- (2) Insertion of the Lead Wire
- When soldering, insert the lead wire into the PCB without mechanically stressing the lead wire.
- Insert the lead wire into the PCB with a distance appropriate to the lead space.



Dimensions Code	Temp. Char.	C0G	X7R	Z5U	Y5V		
1							
	Individual Specification Code A B B	(102J) (5A) Marked on both sides	(222K)	(222M)	(224Z)		
2	Individual Specification Code Except A B B Z	(M 682) J5A	(Massed Massed Mas	(Mase)	(M 25F)		
3, 4,	8			(M105 M5E	(M105 Z5F		
5, 6,	7		(225 K5C)	(M) 225 MSE	(M) 225 25F		
Temperature Ch	naracteristics	Marked with code (C0G char.: A, X7R char.: C, Z5U char.: E, Y5V char.: F) A part is omitted (Please refer to the marking example.)					
Nominal Capacitance		Under 100pF: Actual value 100pF and over: marked with 3 figures					
Capacitance Tolerance		Marked with code					
Rated Voltage		Marked with code (DC25V: 2, DC50V: 5, DC100V: 1) A part is omitted (Please refer to the marking example.)					
Manufacturer's	Identification	Marked with M A part is omitted (Please refer to the marking example.)					



NO.	io. item		Temperature Compensating Type	High Dielectric Constant Type		restivietnoa
1	Operating Temperature -55 to +125°C Chai		Char. X7R: -55 to +125°C Char. Z5U: +10 to +85°C Char. Y5V: -30 to +85°C		_	
2	Rated Voltage	,	See previous pages		which may be appli When AC voltage is	is defined as the maximum v lied continuously to the capa is superimposed on DC volta s larger, should be maintain ltage range.
3	Appearance		No defects or abnormalities		Visual inspection	
4	Dimension and	d Marking	See previous pages		Visual inspection, V	√ernier Caliper
		Between Terminals	No defects or abnormalities		1 1	e current \leq 50mA)
5	Dielectric Strength	Body Insulation	No defects or abnormalities	√o defects or abnormalities		aced in a al balls of 1mm ach terminal, tept n from the balls jure, and 250% tage is 5 sec. between s and metal charge current
6	Insulation Resistance	Between Terminals	C≦0.047μF: 10,000MΩ min. C>0.047μF: 500MΩ • μF min. C: Nominal capacitance		DC voltage not exc	stance should be measured ceeding the rated voltage at unidity and within 2 min. of cle current \leq 50mA)
7	Capacitance		Within the specified tolerance		•	Q/D.F. should be measured a
8	Q/Dissipation	Factor (D.F.)	30pF min.: Q≧1,000 30pF max.: Q≧400+20C C: Nominal capacitance (pF)	30pF max.: Q≧400+20C Char. Z5U}. 0.05 max		Inductive Inductive 1000pF and below more t 1000p 1±0.1MHz 1±0.1k AC0.5 to 5V (r.m.s.) AC1±0 (r.m.s.)
		Capacitance Change	Within the specified tolerance (Table A on last column)	Within the specified tolerance (Table B on last column)	min. at each specifi (1) Temperature Co The temperature co capacitance measu cycling the tempera through 5 (-55 to +	hange should be measured a fied temperature stage. ompensating Type oefficient is determined usin ured in step 3 as a reference ature sequentially from step 125°C) the capacitance shou d tolerance for the temperatu
9	Capacitance Temperature Characteristics	Temperature Coefficient (Table A on last	Within the specified tolerance (Table A on last column)		A. The capacitance differences between measured values in step 3.	eacitance change as shown i e drift is calculated by dividin en the maximum and minimu n step 1, 3 and 5 by the cap. Temperature (C) 25±2
		Capacitance Drift	Within ±0.2% or ±0.05pF (whichever is larger)		25°C value over the	-55±3 25±2 125±3 25±2 Constant Type acitance change compared v e temperature ranges as sho within the specified ranges.

Continued on the following p



NO.	lien	n	Temperature Compensating Type High Dielectric Constant Type		i est ivietnoa	
10	Terminal Strength	Tensile Strength	Termination not to be broken or	loosened	As in the figure, fix the capacitor body, apply the gradually to each lead in the radial direction of th capacitor until reaching 10N and then keep the for applied for 10±1 sec.	
		Bending Strength Termination not to be broken or loosened		Each lead wire should be subjected to a force of and then bent 90° at the point of egress in one direction. Each wire is then returned to the origin position and bent 90° in the opposite direction at rate of one bend per 2 to 3 sec.		
		Appearance	No defects or abnormalities		The capacitor is soldered securely to a supportin	
	Vibration	Capacitance	Within the specified tolerance		terminal and a 10 to 55Hz vibration of 1.5mm pe	
11	Resistance	Q/D.F.	30pF min.: Q≧1,000 30pF max.: Q≧400+20C C: Nominal capacitance (pF)	Char. X7R : 0.025 max. Char. Z5U Char. Y5V): 0.05 max.	peak amplitude is applied for 6 hrs. total, 2 hrs. in mutually perpendicular direction. Allow 1 min. to the frequency from 10Hz to 55Hz and the conver	
12	Solderability o	if Leads	Lead wire should be soldered with uniform coating on the axial direction over 3/4 of the circumferential direction.		The terminal of a capacitor is dipped into a 25% e (JIS-K-8101) solution of rosin (JIS-K-5902) and then into molten solder for 2±0.5 sec. In both cas depth of dipping is up to about 1.5mm to 2mm fre terminal body. Temp. of solder: 245±5°C Lead Free Solder (Sn-3.0Ag 235±5°C H60A or H63A Eutectic Sold	
		Appearance	No defects or abnormalities		The lead wire is immersed in the melted solder	
13	Resistance to	Capacitance Change	Within ±2.5% or ±0.25pF (whichever is larger)	Char. X7R : Within ±7.5% Char. Z5U Char. Y5V	to 2mm from the main body at 270±5°C for 3±0.5 (L3.5 x W3.0 (mm) type) or 350±10°C for 3.5±0.5 (all other types). The specified items are measur after 24±2 hrs. (temperature compensating type) 48±4 hrs. (high dielectric type).	
13	Soldering Heat	Dielectric Strength (Between Terminals)	No defects		 Initial measurement for high dielectric constant The capacitors are heat treated for 1 hr. at 150[±]- allowed to set at room temperature for 48±4 hrs. given an initial measurement. 	
		Appearance	No defects or abnormalities		First, repeat the following temperature/time cycle	
14		Capacitance Change	Within ±5% or ±0.5pF (whichever is larger)	Char. X7R: Within ±12.5% Char. Z5U Char. Y5V) [:] Within ±30%	 times : > lowest operating temperature ±3°C/30±3 min. > ordinary temperature/3 min. max. > highest operating temperature ±3°C/30±3 min 	
	Temperature and	Q/D.F.	30pF min.: Q≥350 10pF to 30pF: Q≥275+5C/2 10pF max.: Q≥200+10C C: Nominal capacitance (pF)	Char. X7R: 0.05 max. Char. Z5U) Char. Y5V) [:] 0.075 max.	» ordinary temperature/3 min. max. Next, repeat twice the successive cycles of imme each cycle consisting of immersion in a fresh wa 65± ⁵ / ₅ °C for 15 min. and immersion in a saturated	
	Immersion Cycle	Insulation Resistance	1,000MΩ or 50MΩ • μF min. (whichever is smaller)		aqueous solution of salt at 0±3°C for 15 min. The capacitor is then promptly washed in running water, drind with a draing aloth, and allowed to a	
		Dielectric Strength (Between Terminals)	No defects or abnormalities		 water, dried with a drying cloth, and allowed to si room temperature for 24±2 hrs. (temperature compensating type) or 48±4 hrs. (high dielectric • Initial measurement for high dielectric constant The capacitors are heat treated for 1 hr. at 150±18°C, allowed to sit at room temperature for ±4 hrs., and given an initial measurement. 	

Continued on the following p



NO	vo. nem		Temperature Compensating Type	High Dielectric Constant Type	rest Method
		Appearance	No defects or abnormalities		Set the capacitor for 500^{+24}_{-20} hrs. at $40\pm2^{\circ}$ C in 90
	Humidity	Capacitance Change	Within ±5% or ±0.5pF (whichever is larger)	Char. X7R : Within ±12.5% Char. Z5U Char. Y5VJ: Within ±30%	Set the capacitor for 500_{-6}^{-6} hrs. at $40\pm2^{\circ}$ C in 90 95% humidity. Remove and set for 24 ± 2 hrs. (temperature compensating type) and 48 ± 4 hrs. dielectric constant type) at room temperature, the
15	,	Q/D.F.	30pF min.: Q≧350 10pF to 30pF: Q≧275+5C/2 10pF max.: Q≧200+10C C: Nominal capacitance (pF)	Char. X7R : 0.05 max. Char. Z5U Char. Y5V) [:] 0.075 max.	 measure. Initial measurement for high dielectric constant The capacitors are heat treated for 1 hr. at 150[±].
		Insulation Resistance	1,000MΩ or 50MΩ • μ F min. (whichever is smaller)		allowed to sit at room temperature for 48±4 hrs. a given an initial measurement.
		Appearance	No defects or abnormalities		
16	Humidity	Capacitance Change	Within ±7.5% or ±0.75pF (whichever is larger)	Char. X7R : Within ±12.5% Char. Z5U Char. Y5V	Apply the rated voltage for $500^{\pm 24}_{0}$ hrs. at $40\pm2^{\circ}_{0}$ in 90 to 95% humidity. Remove and set for 24 ±2 (temperature compensating type) and 48 ±4 hrs.
	Load	Q/D.F.	30pF min.: Q≧200 30pF max.: Q≧100+10C/3 C: Nominal capacitance (pF)	Char. X7R : 0.05 max. Char. Z5U) Char. Y5V): 0.075 max.	(temperature compensating type) and 45±4 ms. dielectric constant type) at room temperature, the measure. (Charge/Discharge current ≤50mA)
		Insulation Resistance	500MΩ or 25MΩ • μ F min. (whichever is smaller)		
		Appearance	No defects or abnormalities		Apply 200% of the rated voltage for 1000^{+48}_{-0} hrs
		Capacitance Change	Within ±3% or ±0.3pF (whichever is larger)	Char. X7R : Within ±12.5% Char. Z5U Char. Y5VJ: Within ±30%	the maximum operating temperature. Remove al for 24±2 hrs. (temperature compensating type) a ±4 hrs. (high dielectric constant type) at room temperature, then measure.
17	High Temperature Load	Q/D.F.	30pF min.: Q≧350 10pF to 30pF: Q≧275+5C/2 10pF max.: Q≧200+10C C: Nominal capacitance (pF)	Char. X7R : 0.04 max. Char. Z5U Char. Y5V) [:] 0.075 max.	 (Charge/Discharge current ≤50mA) Initial measurement for high dielectric constant A voltage treatment should be given to the capacity
		Insulation Resistance	1,000M Ω or 50M Ω • μ F min. (whichever is smaller)		which a DC voltage of 200% of the rated voltage applied for 1 hr. at the maximum operating tempe ±3°C. Then set for 48±4 hrs. at room temperatur conduct initial measurement.
		Appearance	No defects or abnormalities		The capacitor should be fully immersed, unagitat
18	Solvent Resistance	Marking	Legible		reagent at 20 to 25°C for 30±5 sec. and then ren gently. Marking on the surface of the capacitor sl immediately be visually examined. Reagent: • Isopropyl alcohol

Table A

Char.	Nominal Values	Capacitance Change from 25°C (%)					
	(ppm/°C) *1	–55°C		-30°C		-10°C	
	(ppm/°C) i	Max.	Min.	Max.	Min.	Max.	Min.
C0G	0±30	0.58	-0.24	0.40	-0.17	0.25	-0.11

*1: Nominal values denote the temperature coefficient within a range of 25 to 125°C

Table B

Tubic	. D		
Char.	Temp. Range	Reference Temp.	Cap. Change
X7R	–55 to +125°C		Within ±15
Z5U	+10 to + 85°C	25°C	Within ±88
Y5V	-30 to + 85°C		Within ±ଛିଛି



Packaging

Two types of packaging for monolithic ceramic capacitors are available.

1. Bulk Packaging

Minimum Quantity

Dimensions Code	Dimensions (L×W)	Minimum Quantity (pcs./Bag)*	
0	3.6×3.5mm or 4.0×3.5mm or 5.0×3.5mm (Depends on Part Number)		
1	4.0×3.5mm or 4.5×3.5mm or 5.0×3.5mm (Depends on Part Number)		
2	5.0×3.5mm or 5.5×4.0mm or 5.7×4.5mm (Depends on Part Number)		
3	5.0×4.5mm or 5.5×5.0mm or 6.0×5.5mm (Depends on Part Number)	500	
4	7.5×5.5mm	500	
5	7.5×7.5mm or 7.5×8.0mm (Depends on Part Number)		
6	10.0×10.0mm		
8	7.5×5.5mm		
7	12.5×12.5mm	100	
U	7.7×12.5mm or 7.7×13.0mm (Depends on Part Number)	er) 200	
W	5.5×7.5mm or 6.0×8.0mm (Depends on Part Number)	500	

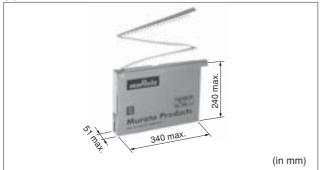
Please order with an integral multiple of the minimum quantity above.

* Minimum Quantity may change depends on part number.

Please check our website 'Product details'.

2. Tape Carrier Packaging

(1) Dimensions of Ammo Pack



(2) Minimum Quantity

Dimensions Code	Dimensions (L×W)	Minimum Quantity (pcs./Ammo Pack)*	
0	3.6×3.5mm or 4.0×3.5mm or 5.0×3.5mm (Depends on Part Number)		
1	4.0×3.5mm or 4.5×3.5mm or 5.0×3.5mm (Depends on Part Number)		
2	5.0×3.5mm or 5.5×4.0mm or 5.7×4.5mm (Depends on Part Number)	2000	
3	5.0×4.5mm or 5.5×5.0mm or 6.0×5.5mm (Depends on Part Number)		
4	7.5×5.5mm		
5	7.5×7.5mm or 7.5×8.0mm (Depends on Part Number)	2000	
6	10.0×10.0mm	4500	
8 7.5×5.5mm		- 1500	
U	7.7×12.5mm or 7.7×13.0mm (Depends on Part Number)	1000	
W	5.5×7.5mm or 6.0×8.0mm (Depends on Part Number)	1500	

Please order with an integral multiple of the minimum quantity above.

* Minimum Quantity may change depends on part number.

Please check our website 'Product details'.

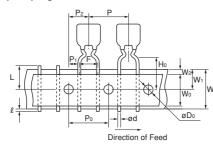
"Minimum Quantity" means the numbers of units of each delivery or order. The quantity should be an integral multiple of the "minimum quantity". (Please note that the actual delivery quantity in a package may change sometimes.)



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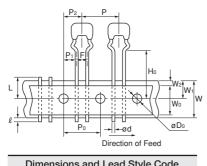
Taping Dimensions

Inside Crimp Taping

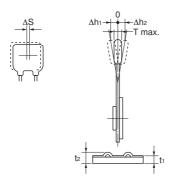


Dimensions and Lead Style Code
Dimensions and Lead Style Code
0M1
1M1
2M1
2M2
3M1
3M2
4M1
4M2
8M1
8M2
WM1

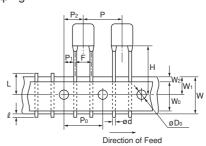
Outside Crimp Taping



Dimensions and Lead Style Code
0S1
1S1
2S1
2S2
3S1
3S2



Straight Taping



Dimensions and Lead Style Code
1DB
2DB
3DB
5E1
5E2
6E1
6E2
UE1

Item	Code	Dim	ensions (mm)	
Pitch of Component	P	12.7±1.0		
Pitch of Sprocket Hole	P0		12.7±0.2	
Lead Spacing	F	2.5 ^{+0.4} _{-0.2} (DB) (S1) (S2)		
			5.0 ^{+0.6} -0.2	
Length from Hole Center to Component Center	P2		6.35±1.3	
	D.		3.85±0.7	
Length from Hole Center to Lead	P1	5.1±0	.7 (DB) (S1) (S2)	
Leau	254±1.	5 Total length	of components pitch \times 20	
Body Dimension	[Depends o	n Part Number	
Deviation Along Tape, Left or Right Defect	ΔS		±2.0	
Carrier Tape Width	W	18.0±0.5		
Position of Sprocket Hole	W1	9.0+0		
Lead Distance between	Ho	16.0±0.5 (M1) (S1)		
Reference and Bottom Plane		20.0±0.5 (M2) (S2)		
For Straight Lead Type	Н	20±0.5 (E2),17.5±0.5 (E1),16±0.5 (DB		
Diameter of Sprocket Hole	Do		4.0±0.1	
Lead Diameter	d		0.5±0.05	
Total Tape Thickness	t1		0.6±0.3	
Total Thickness of Tape and Lead Wire	t2		1.5 max.	
Body Thickness	Т	Depend	ls on Part Number	
		2.0 max.	Dimensions Code: W, U	
Deviation Across Tape	Δh_1 Δh_2	1.5 max.	RHD Series	
		1.0 max.	except as above	
Portion to Cut in Case of Defect	L	11.0+0		
Protrusion Length	l	0.5 max.		
Hold Down Tape Width	Wo	9.5 min.		
Hold Down Tape Position	W2	1.5±1.5		
Coating Extension	0	Depends o	n Dimensions	

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